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## Getting started with the X-NUCLEO-NFC05A1 NFC card reader expansion board based on ST25R3911B for STM32 Nucleo

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### Introduction

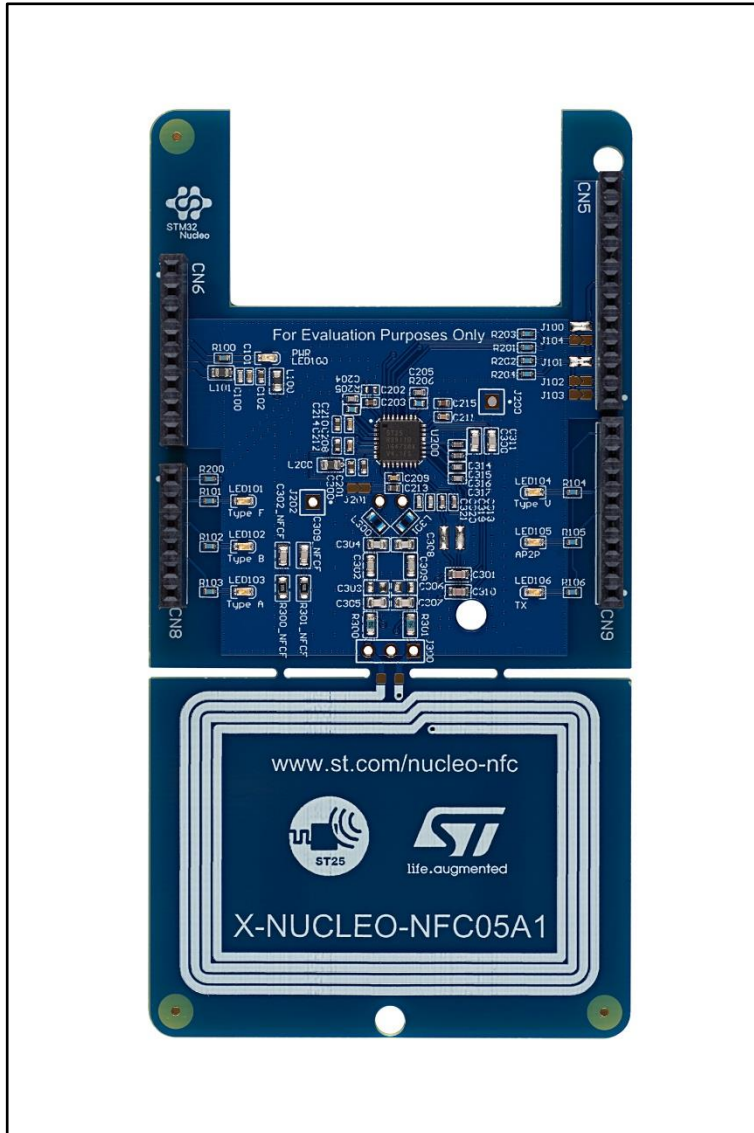
The X-NUCLEO-NFC05A1 NFC card reader expansion board is used to evaluate functions based on the ST25R3911B, designed for the expansion of STM32 Nucleo boards.

It is compatible with the Arduino™ UNO R3 connector and can be plugged to any STM32 Nucleo board together with other expansion boards to evaluate different devices.

It features:

- On-board NFC card reader IC: ST25R3911B
- 47 mm x 34 mm, four turns, 13.56 MHz inductive antenna etched on PCB and associated tuning circuit
- Six general purpose LEDs
- ISO 18092 (NFCIP-1) active P2P
- ISO 14443A and ISO14443B
- ISO 15693
- FeliCa™
- VHBR
  - 6.8 Mbit/s AFE and PCD to PICC framing
  - 3.4 Mbit/s PICC to PCD framing
- Up to 1.4 W output power with differential antenna
- Possibility of driving two antennas in single ended configuration
- Inductive and capacitive wake-up
- Automatic antenna tuning system
- Transparent and Stream modes to implement MIFARE™ Classic compliant or other custom protocols

Figure 1: X-NUCLEO-NFC05A1 expansion board



## Contents

<b>1</b>	<b>Getting started</b> .....	<b>6</b>
1.1	Hardware requirements.....	6
1.2	System requirements .....	6
<b>2</b>	<b>Board setup</b> .....	<b>7</b>
<b>3</b>	<b>Hardware</b> .....	<b>8</b>
3.1	Host interface and GPIO connection.....	9
3.2	X-NUCLEO-NFC05A1 expansion board component placement .....	10
<b>4</b>	<b>Component description</b> .....	<b>11</b>
4.1	ST25R3911B device .....	11
4.2	Schematic diagrams.....	11
4.2.1	USB connectivity and power supply .....	11
4.2.2	ST25R3911B schematic diagram.....	13
4.2.3	Antenna and matching network components .....	15
4.3	PCB Layout.....	17
4.3.1	PCB layers.....	17
4.3.2	Top layer.....	17
4.3.3	Mid layer 1 .....	18
4.3.4	Mid layer 2 .....	18
4.3.5	Bottom layer .....	19
<b>5</b>	<b>Bill of materials</b> .....	<b>20</b>
<b>6</b>	<b>Federal Communications Commission (FCC) and Industry Canada (IC) compliance</b> .....	<b>23</b>
6.1	FCC Compliance Statement.....	23
6.1.1	Part 15.19 .....	23
6.1.2	Part 15.21 .....	23
6.1.3	Part 15.105 .....	23
6.1.4	FCC ID.....	23
6.2	Formal notices required by Industry Canada (“IC”) .....	23
6.2.1	Compliance Statement .....	23
6.2.2	Declaration de Conformité.....	23
6.2.3	IC ID.....	24
<b>7</b>	<b>Revision history</b> .....	<b>25</b>

## List of tables

Table 1: Interconnections between the X-NUCLEO-NFC05A1 expansion board and the Nucleo-L476RG board (left side) .....8

Table 2: Interconnections between the X-NUCLEO-NFC05A1 expansion board and the Nucleo-L476RG board (right side) .....8

Table 3: Matching variant ..... 15

Table 4: X-NUCLEO-NFC05A1 bill of materials .....20

Table 5: Document revision history .....25

## List of figures

Figure 1: X-NUCLEO-NFC05A1 expansion board .....	2
Figure 2: X-NUCLEO-NFC05A1 component placement .....	10
Figure 3: STM32 Nucleo connector schematic diagram .....	12
Figure 4: ST25R3911B schematic diagram .....	14
Figure 5: Matching circuit schematic diagram .....	16
Figure 6: PCB layout top layer .....	17
Figure 7: PCB layout mid layer 1 .....	18
Figure 8: PCB layout mid layer 2 .....	18
Figure 9: PCB layout bottom layer .....	19

# 1 Getting started

Connect the X-NUCLEO-NFC05A1 to an STM32 Nucleo-64 development board. The PC USB port has to be capable of delivering at least 300 mA at 5 V supply. A demo software is available for download at [www.st.com](http://www.st.com) to be programmed onto the STM32 Nucleo.

## 1.1 Hardware requirements

The X-NUCLEO-NFC05A1 expansion board is designed to be used with any STM32 Nucleo board, although complete testing has been performed using the NUCLEO-L476RG hosting the STM32L476RG microcontroller.

The STM32 Nucleo firmware and the related documentation are available at <http://www.st.com/stm32nucleo>.

## 1.2 System requirements

To use the STM32 Nucleo boards with the X-NUCLEO-NFC05A1 expansion board the following software and hardware are required:

- an STM32 Nucleo-64 development board
- a Windows® PC to install the firmware package
- a USB type A to Mini-B USB cable to connect the Nucleo board to the PC
- unit must be supplied by a safety extra low voltage (SELV) limited power source through the USB port, the source should not exceed 60Vdc / 8A / 100VA

To install the board firmware package (order code: X-CUBE-NFC5) the PC must have:

- 128 MB of RAM
- 40 MB of free hard disk space

The X-CUBE-NFC5 firmware and the related documentation are available at [www.st.com](http://www.st.com).

## 2 Board setup

To set up the board;

- 1 Connect the X-NUCLEO-NFC05A1 expansion board to the STM32 Nucleo board from the top through the Arduino® UNO R3 connectors
- 2 Power the STM32 Nucleo board using a Mini-B USB cable
- 3 Program the firmware on the STM32 Nucleo board using the provided example
- 4 Reset the MCU using the reset button available on the STM32 Nucleo board.  
The evaluation kit is ready to be used.

### 3 Hardware

The X-NUCLEO-NFC05A1 expansion board allows the user to test the functionality of the ST25R3911B IC<sup>a</sup>, which supports the reader/writer mode<sup>b</sup>.



Program the microcontroller on the STM32 Nucleo board.

The ST25R3911B IC module and the STM32 Nucleo board are connected through CN5, CN6, CN8 and CN9 connectors (see the tables below).

**Table 1: Interconnections between the X-NUCLEO-NFC05A1 expansion board and the Nucleo-L476RG board (left side)**

Signal	Connector	Pin number	Nucleo-L476RG	X-NUCLEO-NFC05A1
NC	CN6 Power	1	-	-
IOREF		2	-	3V3 (VDD_IO)
RESET		3	-	-
3V3		4	-	3V3 (VDD_IO)
5V		5	-	5V (VDD)
GND		6	-	GND
GND		7	-	GND
VIN		8	-	-
A0	CN8 Analog	1	PA0	IRQ_MCU
A1		2	PA1	MCU_LED1
A2		3	PA4	MCU_LED2
A3		4	PB0	MCU_LED3
A4		5	PC1	-
A5		6	PC0	-

**Table 2: Interconnections between the X-NUCLEO-NFC05A1 expansion board and the Nucleo-L476RG board (right side)**

Signal	Connector	Pin number	Nucleo-L476RG	X-NUCLEO-NFC05A1
D15	CN5 Digital	10	PB8	-
D14		9	PB9	-
AVDD		8	AVDD	-
GND		7	GND	GND
D13		6	PA5	CLK_MCU

<sup>a</sup> For the chip complete feature list refer to the ST25R3911B datasheet.

<sup>b</sup> For further details on the supported features, refer to this user manual introduction.



Signal	Connector	Pin number	Nucleo-L476RG	X-NUCLEO-NFC05A1
D12		5	PA6	MISO_MCU
D11		4	PA7	MOSI_MCU
D10		3	PB6	/SS_MCU
D9		2	PC7	-
D8		1	PA9	-
D7	CN9 Digital	8	PA8	MCU_LED6
D6		7	PB10	-
D5		6	PB4	MCU_LED4
D4		5	PB5	MCU_LED5
D3		4	PB3	-
D2		3	PA10	-
D1		2	PA2	-
D0		1	PA3	-

### 3.1 Host interface and GPIO connection

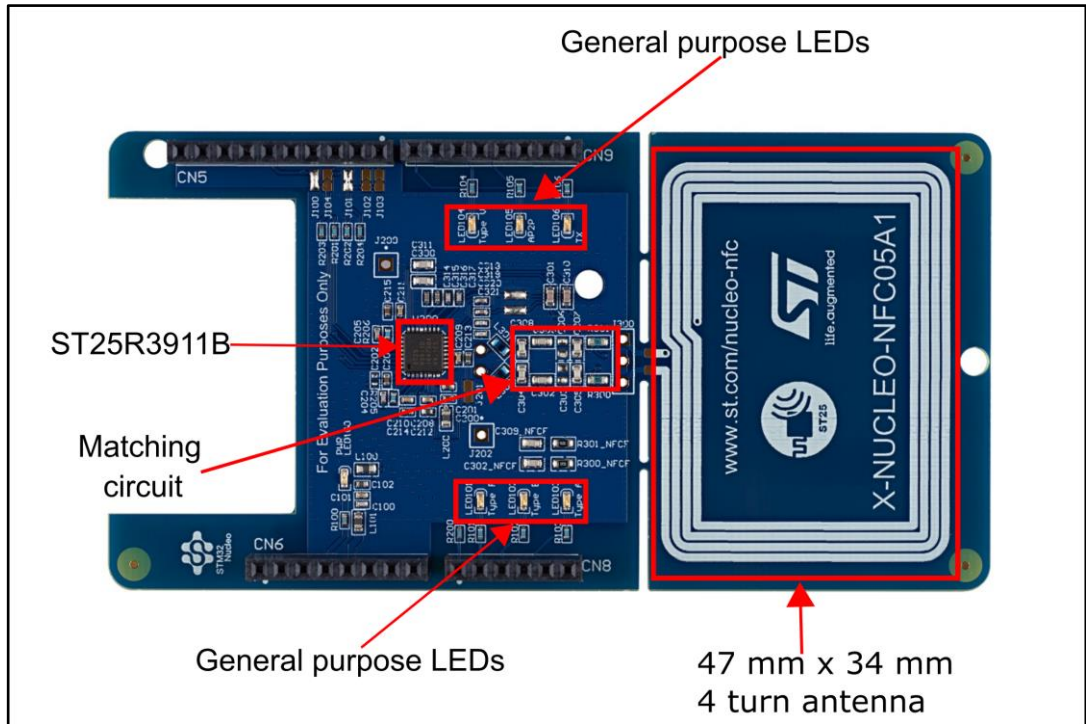
The X-NUCLEO-NFC05A1 expansion board contains the ST25R3911B-AQFT chip and is powered by the STM32 Nucleo board.

The ST25R3911B is driven by the microcontroller via SPI interface.

The six LEDs indicate the detected technology (for example ISO14443 Type A).

### 3.2 X-NUCLEO-NFC05A1 expansion board component placement

Figure 2: X-NUCLEO-NFC05A1 component placement



## 4 Component description

### 4.1 ST25R3911B device

The ST25R3911B-AQFT is a highly integrated NFC initiator/HF reader IC embedding:

- the analog front end (AFE) and a highly integrated data framing system for:
  - ISO 18092 (NFCIP-1) initiator
  - ISO 18092 (NFCIP-1) active target
  - ISO 14443A and B reader (including high bit rates)
- FeliCa™ reader

The implementation of other standard and custom protocols (like MIFARE™ Classic) is possible by using the AFE and implementing framing in the external microcontroller (Stream and Transparent modes).

### 4.2 Schematic diagrams

#### 4.2.1 USB connectivity and power supply

The X-NUCLEO-NFC05A1 expansion board can be connected via Arduino® UNO R3 connectors to the STM32 Nucleo board.

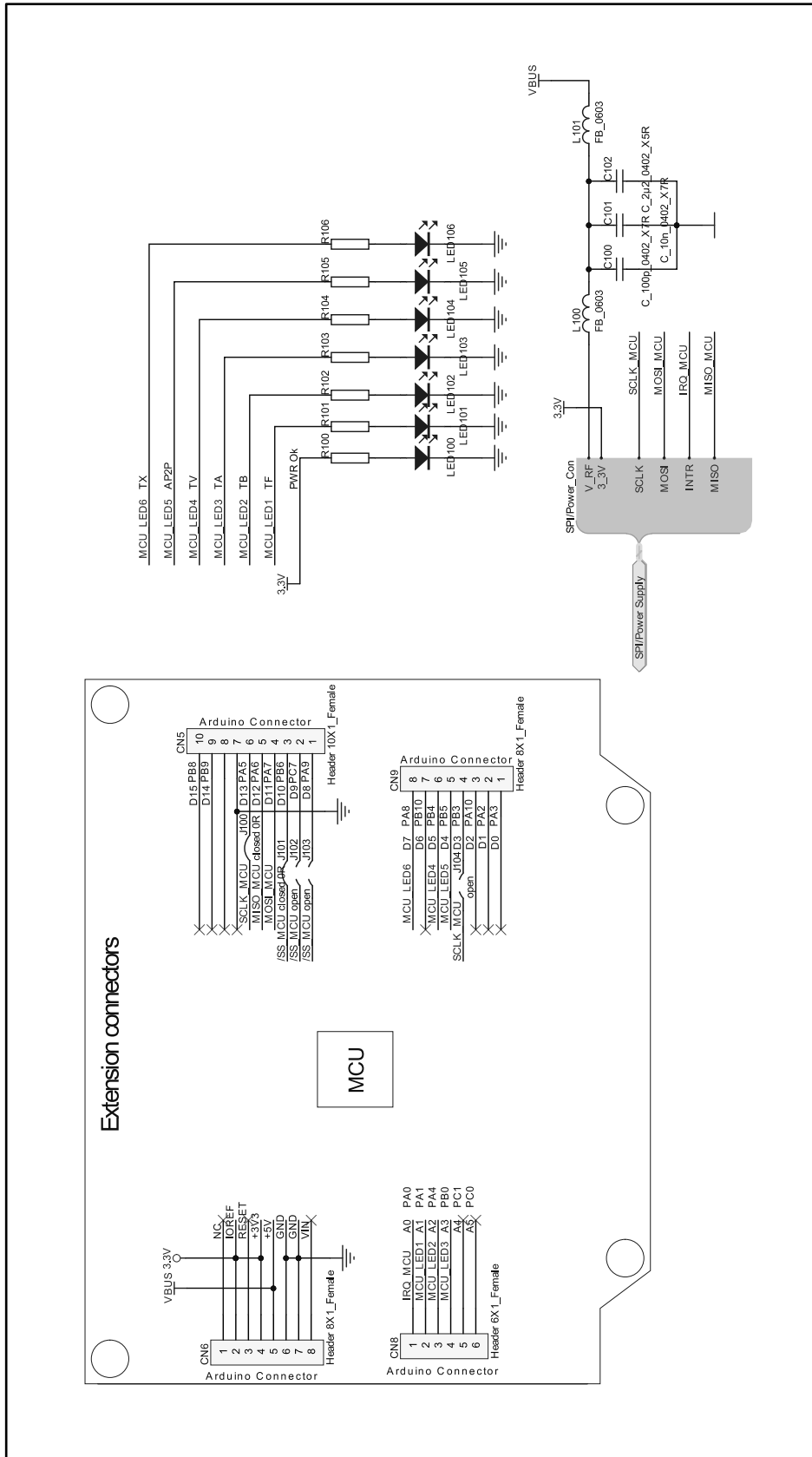
A green LED indicates if the 5 V supply is present on the X-NUCLEO-NFC05A1 expansion board.

The six status LEDs are controlled via MCU.

Additional components are placed for the 5 V supply filtering.

Several solder jumpers enable an alternative connection of SCLK\_MCU and /SS\_MCU to the STM32 MCU.

Figure 3: STM32 Nucleo connector schematic diagram



#### 4.2.2 ST25R3911B schematic diagram

The ST25R3911B is directly connected to the filtered 5 V USB supply. There are additional supply filtering components placed close to the NFC/HF reader IC.

Jumper JP200 can be used to measure the chip supply current.

If this measurement is performed, the ferrite bead L301 has to be removed.

Capacitors 200 to 203 provide additional filtering of the ST25R3911B supply.

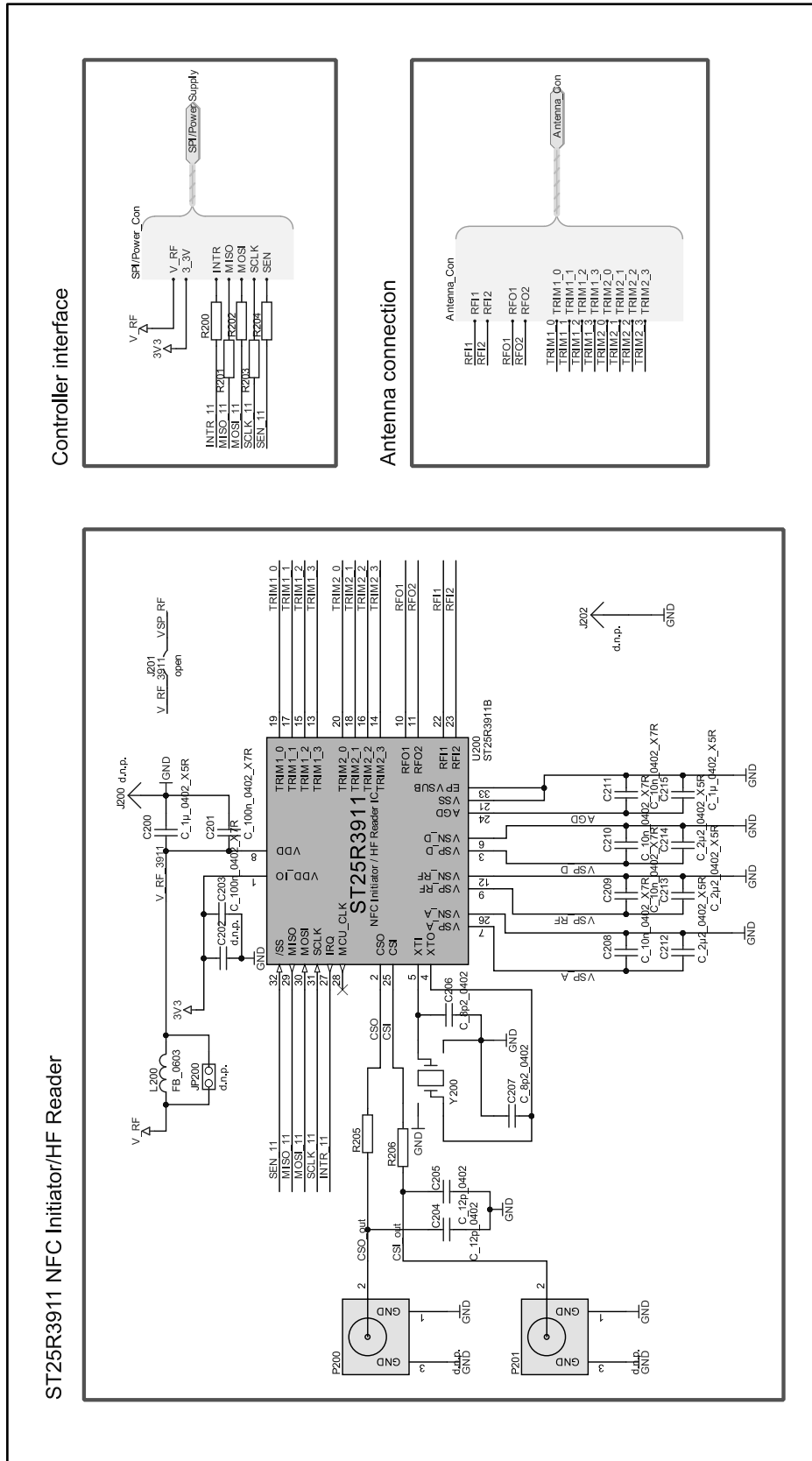
During layout all decoupling capacitors have been placed as close as possible to the ST25R3911B chip. Special care has been taken for C209, C201, C213 and C200 since these decoupling capacitors are used for the high power driver stage.

To demonstrate the capacitive wake-up feature, two capacitive electrodes are placed on the PCB. Additional electrodes can be connected using the P200 and P201 UFL connectors.

For SPI cross-connecting another reader PCB, the resistors R200 to R204 can be removed.

J201 allows to bypass the internal VSP\_RF regulator in case the output current is > 200 mA and needs to be supported.

Figure 4: ST25R3911B schematic diagram



### 4.2.3 Antenna and matching network components

This schematic diagram contains the matching network and the automatic antenna tuning capacitors as well as the alternative NFC Forum matching components.

In the default configuration, the X-NUCLEO-NFC05A1 expansion board is populated with a VHBR tuning, which allows communication to speed up to 3.4 Mbps.

The Q-factor is doubled and bitrates up to 848kbps are supported, by switching the components listed in the following table.

**Table 3: Matching variant**

VHBR Matching	NFC Forum Matching
C302	C302_NFCF
C309	C309_NFCF
R300	R300_NFCF
R301	R301_NFCF

To support VHBR bit rates, the antenna is matched to a system Q-Factor of 8.

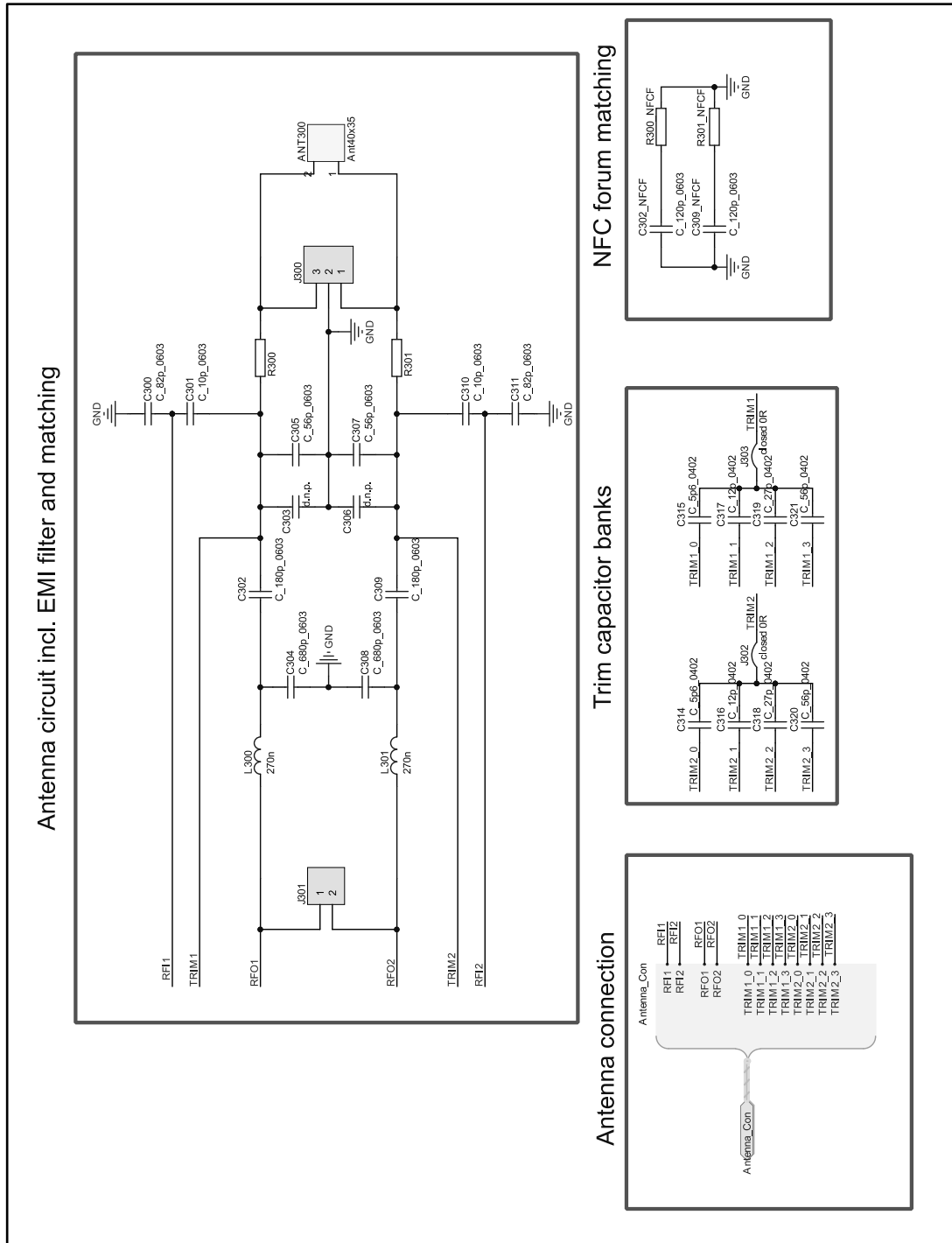
By switching to the NFC Forum matching components, the system Q-Factor is increased to 16. This can increase read range by up to 20% depending on the communication technology, but limits the maximum supported bit rate to 848kbps.<sup>a</sup>

The etched PCB antenna can be easily removed from the expansion board to connect a custom antenna using the connector J300.

The matching topology supports the connection of one custom differential antenna or two single-ended antennas. The two single-ended antennas can then be multiplexed in software using the **single** and **rfo2** bits of **IO Configuration Register 1**.

<sup>a</sup> Further information about antenna matching can be found at [www.st.com/st25r](http://www.st.com/st25r)

Figure 5: Matching circuit schematic diagram





## 4.3 PCB Layout

### 4.3.1 PCB layers

As the ST25R3911B is a high power RF transmitter, the NFC reader layout must be done carefully.

The decoupling capacitors are located as close as possible to the positive and negative power supply pins (for example VSP\_RF and VSN\_RF).

Since the chip is using a differential output driver stage, the antenna matching network is treated as a differential network.

The space between the components is kept as small as possible and the whole network is routed completely symmetrical.

Via stitching and via shielding is used to maintain a low impedance and prevent short return current loops.

The RF traces are protected by via stitching in combination with guard rings to create a via wall: this keeps the PCB electromagnetically 'quiet'.

A via shield is used to create a vertical copper barrier through the PCB, to help reduce crosstalk and electromagnetic interference in a route carrying an RF signal.

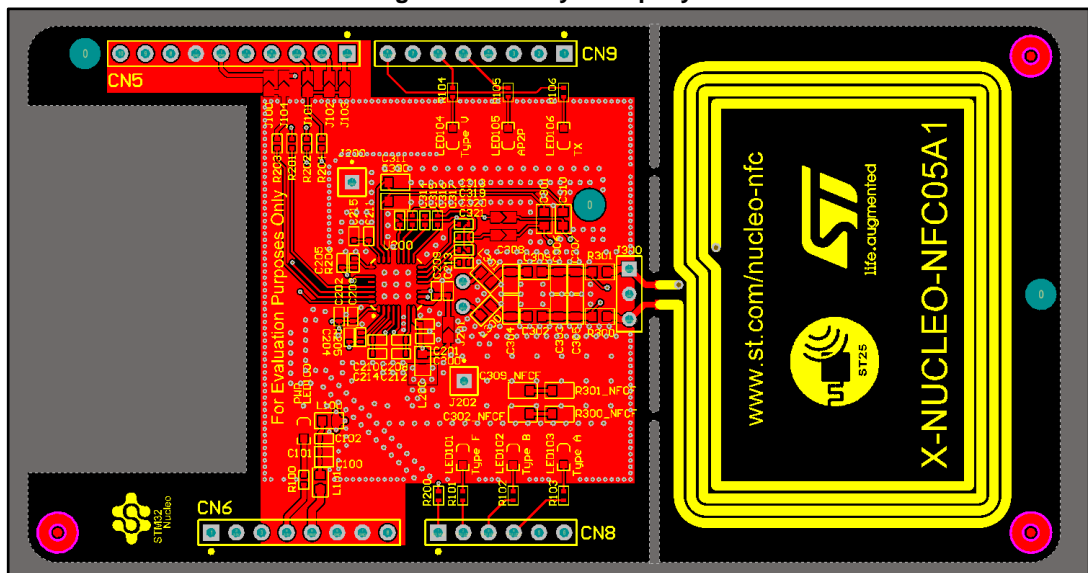
The RFI traces and AAT lanes are routed as close as possible to each other.

### 4.3.2 Top layer

The top layer contains most of the components and PCB traces. The unused areas around the IC are filled with GND planes guarded using via stitching.

The important analog traces are surrounded by GND vias.

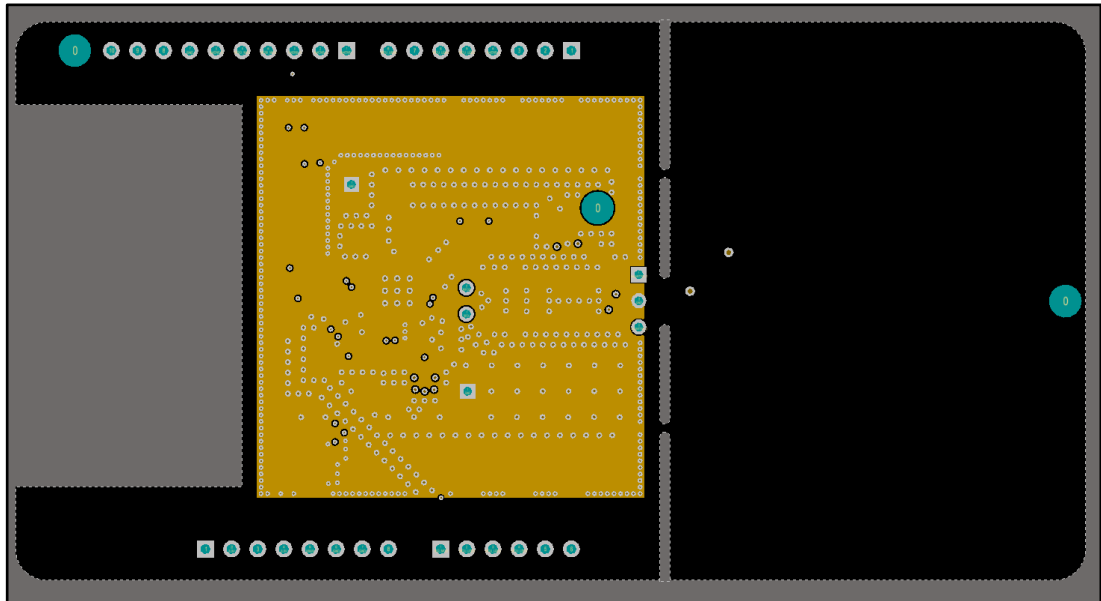
Figure 6: PCB layout top layer



### 4.3.3 Mid layer 1

The mid layer 1 is a pure GND plane. It provides a low ohmic DC path for the GND connection.

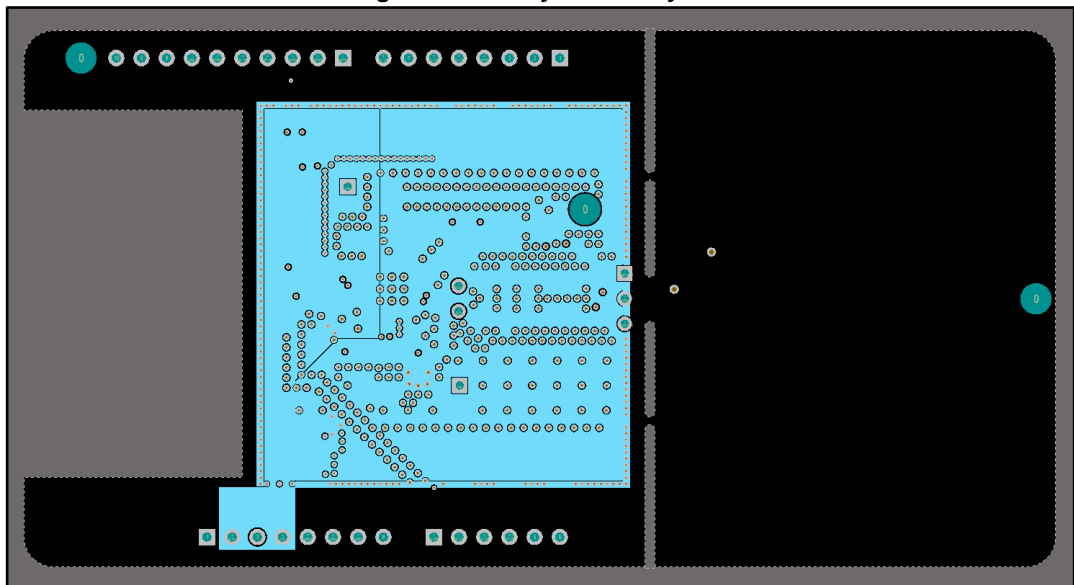
Figure 7: PCB layout mid layer 1



### 4.3.4 Mid layer 2

Mid layer 2 is used for power distribution. It contains the power planes for the ST25R3911B 5 V supply and the 3.3 V to communicate with the STM32 Nucleo board.

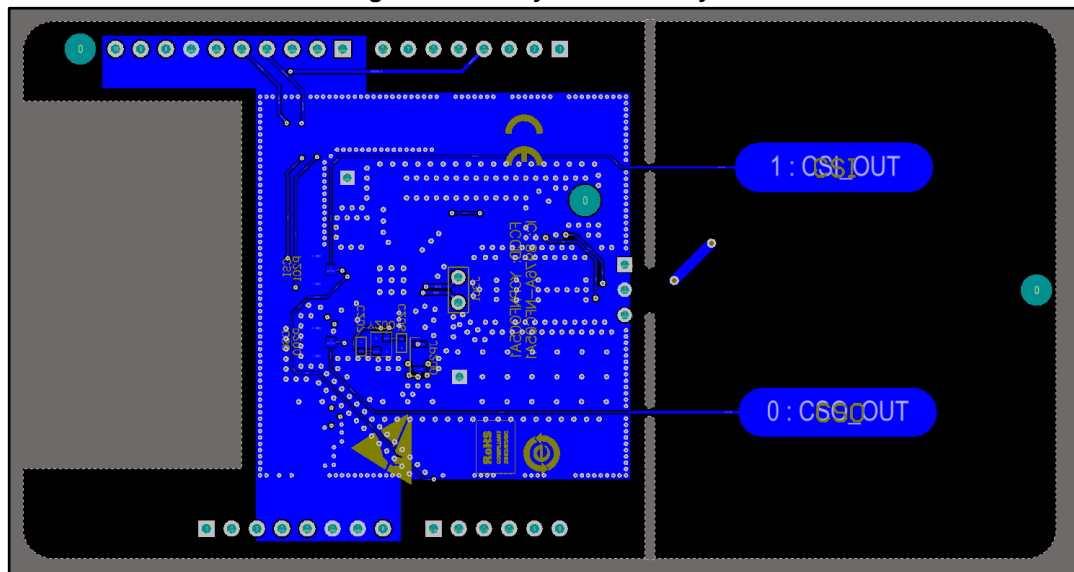
Figure 8: PCB layout mid layer 2



### 4.3.5 Bottom layer

The bottom layer is mainly GND plane. Some traces are routed through the bottom plane.

Figure 9: PCB layout bottom layer



## 5 Bill of materials

Table 4: X-NUCLEO-NFC05A1 bill of materials

Item	Q.ty	Ref.	Part/Value	Description	Manufacturer	Order code
1	0	C202		DNM		
2	0	J300		DNM		
3	0	J301		DNM		
4	0	JP200		DNM		
5	0	C303, C306		DNM		
6	0	J200, J202		DNM		
7	1	C100	0402, 0.01 $\mu$ F, 25 V, $\pm$ 10%, X7R		AVX	0402YC101KAT2A
8	5	C101, C208, C209, C210, C211	0402, 0.01 $\mu$ F, 25 V, $\pm$ 10%, X7R		AVX	04023C103KAT2A
9	0	P200, P201		DNM	HRS (HIROSE)	U.FL-R-SMT-1(10)
10	1	LED100		Green LED	Lite-On	LTST-C190KGKT
11	6	LED101, LED102, LED103, LED104, LED105, LED106		Blue LED	Lite-On	LTST-C190TBKT
12	2	C201, C203	0402, 0.1 $\mu$ F, 10 V, $\pm$ 10%, X5R,		MULTICOMP	MC0402X104K100CT
13	2	C301, C310	0603, 10 pF, 50 V, 1%, C0G / NP0		MULTICOMP	MC0603N100F500CT
14	4	J100, J101, J302, J303			MULTICOMP	MC00625W040210R
15	1	Y200		Crystal	MURATA	XRCGB27M120F3M00R0
16	2	C200, C215	0402, 1 $\mu$ F, 16 V, $\pm$ 10%, X5R,		MURATA	GRM155R61C105KA12D
17	2	C206, C207	0402, 8.2 pF, 50 V, $\pm$ 0.25 pF, C0G / NP0		MURATA	GRM1555C1H8R2CA01D

Item	Q.ty	Ref.	Part/Value	Description	Manufacturer	Order code
18	2	C300, C311	82 pF ±1% 50 V C0G, NP0 0603		MURATA	GRM1885C1H820FA01D
19	2	C302, C309	180 pF ±2% 50 V C0G, NP0 0603		MURATA	GRM1885C1H181GA01D
20	2	C302_NF CF, C309_NF CF	120 pF ±2% 50 V C0G, NP0 0603		MURATA	GRM1885C1H121GA01D
21	2	C304, C308	680 pF ±2% 50 V C0G, NP0 0603		MURATA	GRM1885C1H681GA01D
22	2	C305, C307	56 pF ±2% 50 V C0G, NP0 0603		MURATA	GRM1885C1H560FA01D
23	2	C314, C315	5.6 pF ±0.5 pF 50 V C0G, NP0 0402		MURATA	GRM1555C1H5R6DA01D
24	2	C318, C319	27 pF ±2% 50 V C0G, NP0 0402		MURATA	GRM1555C1H270GA01D
25	2	C320, C321	56 pF ±2% 50 V C0G, NP0 0402		MURATA	GRM1555C1H560GA01D
26	2	L300, L301	270 nH 260 mA 2.42 Ohm Max 0603, SFR@1.25 GHz, Q>24@100 MHz"	Unshielded Wirewound Inductor	MURATA	LQW18ANR27G80D
27	3	L100, L101, L200			MURATA	BLM18EG471SN1D
28	4	C102, C212, C213, C214	0402, 2.2 µF, 6.3 V, ± 20%, X5R		MURATA	GRM155R60J225ME15D
29	4	C204, C205, C316, C317	12 pF ±2% 50 V C0G, NP0 0402		MURATA	GRM1555C1H120GA01D

Item	Q.ty	Ref.	Part/Value	Description	Manufacturer	Order code
30	8	R101, R102, R103, R104, R105, R106, R205, R206	1 kohm, 50 V, 0402, >100 mW, ± 5%		Panasonic	ERJ2GEJ102X
31	1	CN5		Header 10X1_Female	Samtec	SSQ-110-03-L-S
32	1	CN8		Header 6X1_Female	Samtec	SSQ-106-03-L-S
33	2	CN6, CN9		Header 8X1_Female	Samtec	SSQ-108-03-L-S
34	1	U200			ST	ST25R3911B-AQFT
35	2	R300_NF CF, R301_NF CF	1.96 Ohm ±1% 0.1 W, 1/10 W 0603	Chip Resistor	Vishay Dale	CRCW06031R96FKEA
36	1	R100	680 Ohm ±5% 0.063 W, 1/16 W 0402	Chip Resistor	Yageo	RC0402JR-07680RL
37	2	R300, R301	5.6 Ohm ±5% 0.1 W, 1/10 W 0603	Chip Resistor	Yageo	RC0603FR-075R62L
38	5	R200, R201, R202, R203, R204	220 Ohm ±5% 0.063 W, 1/16 W 0402	Chip Resistor	Yageo	RC0402JR-07220RL

## **6 Federal Communications Commission (FCC) and Industry Canada (IC) compliance**

### **6.1 FCC Compliance Statement**

#### **6.1.1 Part 15.19**

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

#### **6.1.2 Part 15.21**

Any changes or modifications to this equipment not expressly approved by STMicroelectronics may cause harmful interference and void the user's authority to operate this equipment.

#### **6.1.3 Part 15.105**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### **6.1.4 FCC ID**

FCC ID: YCPNFC05A1

## **6.2 Formal notices required by Industry Canada ("IC")**

### **6.2.1 Compliance Statement**

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation.

### **6.2.2 Declaration de Conformité**

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter

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tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

**6.2.3 IC ID**

IC ID: 8976A-NFC05A1



## 7 Revision history

Table 5: Document revision history

Date	Version	Changes
06-Jul-2017	1	Initial release
31-Jul-2017	2	Added <a href="#">Section 6.1.3: "Part 15.105"</a>

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